#### Augat

TE Internal #: 2-1437504-9

Transistor Sockets, 3 Position, Low Connector Profile, TO-3 Package Outline Dimensions, Lead Size (Accepted) .04 in [1.02

mm], Through Hole - Solder

View on TE.com >



Connectors > Socket Connectors > Transistor Sockets











Number of Positions: 3

Connector Profile: Low

Package Outline Dimensions: TO-3
Lead Size (Accepted): 1.02 mm [ .04 in ]

Termination Method to Printed Circuit Board: Through Hole - Solder

### **Features**

#### **Product Type Features**

Product Type Features	
Terminal Configuration	Contact
Package Outline Dimensions	TO-3
Connector & Contact Terminates To	Printed Circuit Board
Product Type	Socket
Configuration Features	
Number of Solder Lugs	2
Number of Positions	3
Body Features	
Insulator Material	Phenolic
Connector Profile	Low
Lead Size (Accepted)	1.02 mm[.04 in]
Contact Features	

Beryllium Copper

Tin

Terminal Material

Terminal Plating



Contact Current Rating (Max)	10 A
Socket Type	Transistor
	.04 in
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Connector Mounting Type	Board Mount
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Insulator Flammability Rating	UL 94V-0

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products



will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Customers Also Bought





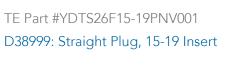


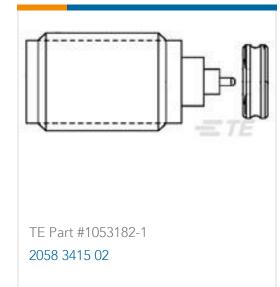


















# **Documents**

**Product Drawings** 

8080-1G1=TRANSISTOR SOCKET ASS

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2-1437504-9\_G.2d\_dxf.zip

English

**Customer View Model** 

Transistor Sockets, 3 Position, Low Connector Profile, TO-3 Package Outline Dimensions, Lead Size (Accepted) .04 in [1.02 mm], Through Hole - Solder



ENG\_CVM\_CVM\_2-1437504-9\_G.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-1437504-9\_G.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.